



THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Reissue of U.S. Patent No. 6,329,213
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Inventor Mark E. Tuttle et al.
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Group Art Unit 2891
Examiner Caridad Everhart
Customer No. 021567
Attorney Docket No. MI40-389
Title: Methods for Forming Integrated Circuits Within Substrates

AMENDMENT AFTER NOTICE OF ALLOWANCE
PURSUANT TO 37 CFR §1.312 AND §1.173

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AMENDMENTS

Responsive to the Notice of Allowance dated August 29, 2007 in this Reissue application, Applicants amend and remark as follows. Unless otherwise indicated, deletions are [bracketed], additions are underlined to indicate changes relative to the patent.